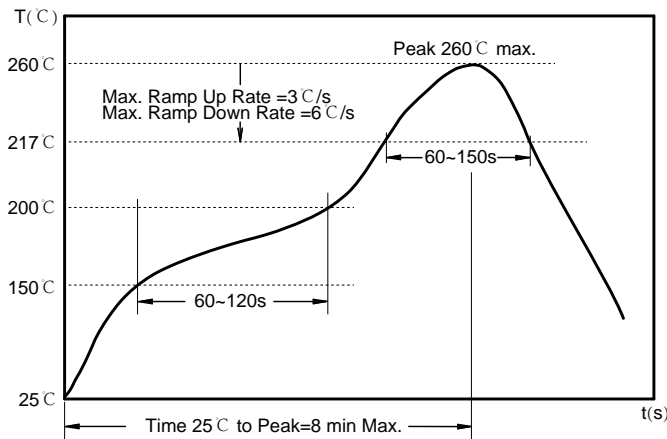


Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.

Allowed time above 217 °C: 60~150 sec.

Max temperature: 260 °C.

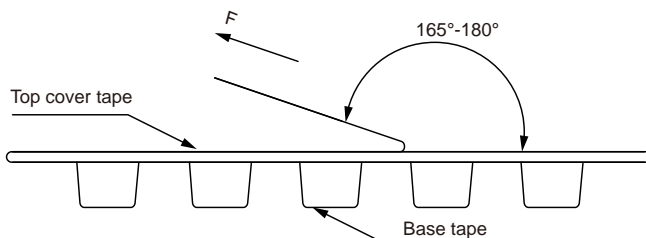
Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
SCM9250	6.5 typ	9.7 typ	1.5± 0.1	4.0± 0.1	12.0± 0.1	16.0± 0.3	5.7 ref	1.75± 0.1	0.4± 0.1

Peel force of top cover tape:

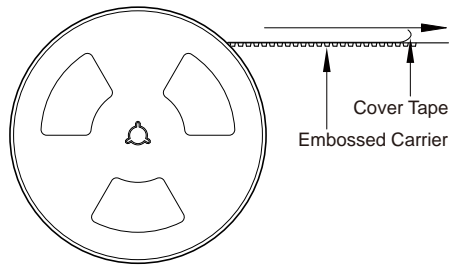


The peel force of top cover tape shall be between 0.1 to 1.3 N

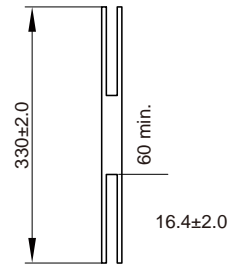
Product Marking:

Marking	Dot+Printing Duplex winding) /Printing Split winding)
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Reel Dimension : [mm]



2.2±0.5



Packaging Quantity:

1000 Pcs/Reel

2 Reel /Inner box(2000 Pcs)

3 Inner box/Carton box(6K Pcs)

Cautions and Warnings:

Storage Conditions:

Operation Instructions: